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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KWANG-SEONG CHOI	05/28/2013
Yong Sung EOM	05/28/2013
Hyun-cheol BAE	05/28/2013
Haksun LEE	05/28/2013

RECEIVING PARTY DATA

Name:	Electronics and Telecommunications Research Institute	
Street Address:	161, Gajeong-dong, Yuseong-gu,	
City:	Daejeon	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	305-700	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13904572

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	KOR-416
NAME OF SUBMITTER:	Robert H. Berdo, Jr.
Signature:	/Robert H. Berdo, Jr./
	PATENT

REEL: 030717 FRAME: 0593

DP \$40.00 1390457;

Date:	07/01/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 2 source=ASSIGNMENT_13904572#page1.tif source=ASSIGNMENT_13904572#page2.tif	

PATENT REEL: 030717 FRAME: 0594

Attorney Reference: Client Reference: IP20130016

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS CHOI, KWANG-SEONG; EOM, Yong Sung; BAE, Hyun-cheol; and LEE, Haksun of Republic of Korea hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

METHODS OF FORMING BUMP AND SEMICONDUCTOR DEVICE WITH THE SAME

[X] said application being attach	ed hereto;			
[] said application having been	filed in the United States Patent and Trademark Office on			
	, as Application Serial No,	and	was	amended
on	(if applicable);			
[] the specification of which was	s filed under the Patent Cooperation Treaty on		,	
Serial No,	the United States of America being designated.			

AND WHEREAS <u>Electronics and Telecommunications Research Institute of 161, Gajeong-dong, Yuseong-gu, Daejeon 305-700, Republic of Korea.</u> hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assigner, the receipt of which is hereby acknowledged, said assigner hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Address all correspondence and telephone calls to Rabin & Berdo, P.C., 1101 14th Street, N.W., Suite 500, Washington, D.C. 20005, Telephone: (202) 371-8976; Fax: (202) 408-0924, Customer No. 23995.

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Continued -Page 2 ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WITNESS:	ASSIGNOR (THE FIRST INVENTOR):		
Signature:	Legal Name: CHOI, KWANG-SEONG		
WITNESS:	ASSIGNOR (THE SECOND INVENTOR):		
Signature: Name: Address:	Legal Name: <u>EOM, Yong Sung</u>		
WITNESS:	ASSIGNOR (THE THIRD INVENTOR):		
Signature: Signature: Gy Ru M Name: Legal Name: BAE, Hyun-cheol Address: Date: 28, MAY, 20/3			
WITNESS:	ASSIGNOR (THE FOURTH INVENTOR):		
Signature:Name:Address:	Legal Name: LEE, Haksun		

PATENT REEL: 030717 FRAME: 0596

RECORDED: 07/01/2013